Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

the specification of	which is attached hereto unless the fo	llowing is checked:		
and specification of	which is attached hereto diffess the to	nowing is checked.		
w	as filed on	as Unit	as United States Application Number or PCT International	
A	ication Number		and was amended on	
- (i	pplicable).			
I hereby state that I by any amendment	have reviewed and understand the co referred to above.	ntents of the above-identified	d specification, including the claim	n(s), as amended
I acknowledge the o	luty to disclose information which is m	aterial to patentability as defi	ined in Title 37, Code of Federal R	tegulations, § 1.56.
inventor's certificat	ign priority benefits under Title 35, Under listed below and have also identified of the application on which priority is	I below any foreign applicat		cate having a fil-
[] [](List prior	2000-067635	Japan	10/March/2000	Priority Claimed Yes 🗆 No
foreign	2001-032310 (Number)	(Country) Japan	(Day/Month/Year Filed) 8/February/2001	O21 Yes □ No
applications. See note A	(Number)	(Country)	(Day/Month/Year Filed)	.
on back of this page)	(Number)	(Country)	(Day/Month/Year Filed)	_
af D	(Number)	(Country)	(Day/Month/Year Filed)	
See note B on bac	k of this page) See attack	ched list for additional prior	foreign applications	
1 m	penefit under Title 35, United States C	ode, § 119(e) of any United	States provisional application(s) l	listed below.
Fhereby claim the l				
Fhereby claim the l	(Application Numb	er)	(Filing Date)	
Fhereby claim the l	(Application Numb		(Filing Date) (Filing Date)	-
I hereby claim the subject matter of eathe first paragraph ity as defined in Ti		ode, § 120 of any United St not disclosed in the prior Un I acknowledge the duty to a 1.56 which became available	(Filing Date) tates application(s) listed below an nited States application in the man disclose information which is mate	nner provided by erial to patentabil-
I hereby claim the subject matter of eathe first paragraph ity as defined in Ti	(Application Numb benefit under Title 35, United States Cach of the claims of this application is of Title 35, United States Code, § 112 tle 37, Code of Federal Regulations, §	ode, § 120 of any United St not disclosed in the prior Un I acknowledge the duty to a 1.56 which became available	(Filing Date) tates application(s) listed below an nited States application in the man disclose information which is mate	nner provided by erial to patentabil- rior application

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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